PHP20N06T



N-channel TrenchMOS standard level FET

Rev. 02 — 27 November 2009

Product data sheet

1. Product profile

1.1 General description

Standard level N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using TrenchMOS technology. This product is designed and qualified for use in computing, communications, consumer and industrial applications only.

1.2 Features and benefits

- Low conduction losses due to low on-state resistance
- Suitable for high frequency applications due to fast switching characteristics

1.3 Applications

DC-to-DC convertors

Switched-mode power supplies

1.4 Quick reference data

Table 1. Quick reference

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-------------------|-------------------------------------|--|-----|-----|------|------|
| V_{DS} | drain-source voltage | T _j ≥ 25 °C; T _j ≤ 175 °C | - | - | 55 | V |
| I_D | drain current | T_{mb} = 25 °C; V_{GS} = 10 V; see <u>Figure 3</u> and <u>1</u> | - | - | 20.3 | Α |
| P _{tot} | total power dissipation | T _{mb} = 25 °C;see <u>Figure 2</u> | - | - | 62 | W |
| Dynamic | characteristics | | | | | |
| Q_{GD} | gate-drain charge | $V_{GS} = 10 \text{ V}; I_D = 25 \text{ A};$ $V_{DS} = 44 \text{ V}; T_j = 25 \text{ °C};$ see Figure 13 | - | 6 | - | nC |
| Static ch | aracteristics | | | | | |
| R _{DSon} | drain-source on-state resistance | $V_{GS} = 10 \text{ V}; I_D = 10 \text{ A};$ $T_j = 175 \text{ °C};$ see Figure 11 and 12 | - | - | 150 | mΩ |
| | | $V_{GS} = 10 \text{ V}; I_D = 10 \text{ A};$ $T_j = 25 \text{ °C};$ see Figure 11 and 12 | - | 64 | 75 | mΩ |



2. Pinning information

Table 2. Pinning information

| Pin Symbol Description 1 G gate 2 D drain 3 S source mb D mounting base; connected to drain | |
|--|----------------|
| 2 D drain 3 S source mb D mounting base; connected to drain | Graphic symbol |
| 3 S source mb D mounting base; connected to drain | _ |
| mb D mounting base; connected to drain | D |
| drain | |
| | mbb076 S |
| SOT78 (TO-220AB) | |

3. Ordering information

Table 3. Ordering information

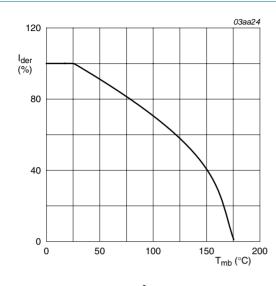
| Type number | mber Package | | | | | |
|-------------|--------------|--|---------|--|--|--|
| | Name | Description | Version | | | |
| PHP20N06T | TO-220AB | plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB | SOT78 | | | |

4. Limiting values

Table 4. Limiting values

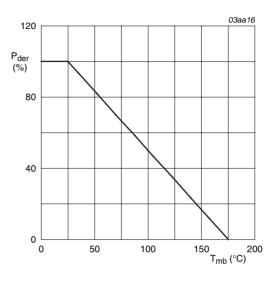
In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|----------------------|--|--|-----|------|------|
| V_{DS} | drain-source voltage | $T_j \ge 25 ^{\circ}\text{C}; T_j \le 175 ^{\circ}\text{C}$ | - | 55 | V |
| V_{DGR} | drain-gate voltage | $R_{GS} = 20 \text{ k}\Omega$ | - | 55 | V |
| V_{GS} | gate-source voltage | | -20 | 20 | V |
| I_D | drain current | V _{GS} = 10 V; T _{mb} = 100 °C; see <u>Figure 1</u> | - | 14.3 | Α |
| | | $V_{GS} = 10 \text{ V}; T_{mb} = 25 \text{ °C}; \text{ see } \frac{\text{Figure 3}}{\text{Mode } 100 \text{ Figure } 100 } \text{ and } \frac{1}{100 } $ | - | 20.3 | Α |
| I_{DM} | peak drain current | $t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$; see Figure 3 | - | 81 | Α |
| P _{tot} | total power dissipation | T _{mb} = 25 °C; see <u>Figure 2</u> | - | 62 | W |
| T _{stg} | storage temperature | | -55 | 175 | °C |
| Tj | junction temperature | | -55 | 175 | °C |
| Source-dr | ain diode | | | | |
| I _S | source current | $T_{mb} = 25 ^{\circ}C$ | - | 20.3 | Α |
| I _{SM} | peak source current | $t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$ | - | 81 | Α |
| Avalanche | ruggedness | | | | |
| E _{DS(AL)S} | non-repetitive drain-source avalanche energy | V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; I_D = 11 A; $V_{sup} \le$ 55 V; R_{GS} = 50 Ω; unclamped | - | 30.3 | mJ |



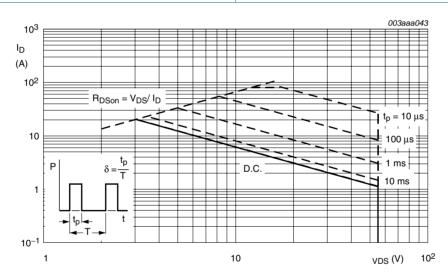
$$I_{der} = \frac{I_D}{I_{D(25^{\circ}C)}} \times 100\%$$

Fig 1. Normalized continuous drain current as a function of mounting base temperature



$$P_{der} = \frac{P_{tot}}{P_{tot(25^{\circ}C)}} \times 100\%$$

Fig 2. Normalized total power dissipation as a function of mounting base temperature



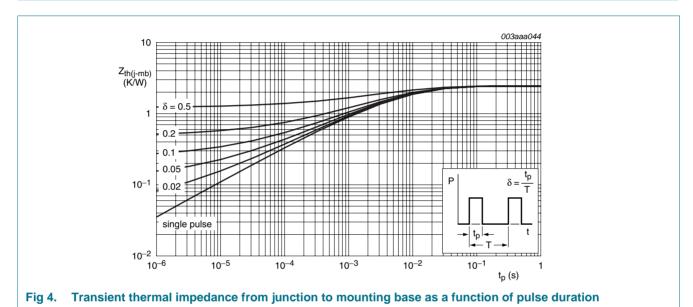
 $T_{mb} = 25$ °C; I_{DM} is single pulse

Fig 3. Safe operating area; continuous and peak drain currents as a function of drain-source voltage

5. Thermal characteristics

Table 5. Thermal characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------------|---|-----------------------|-----|-----|-----|------|
| $R_{th(j-mb)}$ | thermal resistance from junction to mounting base | see Figure 4 | - | - | 2.4 | K/W |
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | vertical in still air | - | 60 | - | K/W |



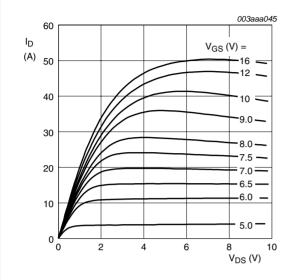
6. Characteristics

Table 6. Characteristics

| Table 6. | Characteristics | O Professional Professiona Professiona Professiona Professiona Professiona Professi | p | - | | |
|---------------------|-----------------------------------|--|-----|------|-----|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| | racteristics | | | | | |
| $V_{(BR)DSS}$ | drain-source breakdown voltage | $I_D = 0.25 \text{ mA}; V_{GS} = 0 \text{ V}; T_j = -55 \text{ °C}$ | 50 | - | - | V |
| | | $I_D = 0.25 \text{ mA}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$ | 55 | - | - | V |
| $V_{GS(th)}$ | gate-source threshold voltage | $I_D = 1 \text{ mA}$; $V_{DS} = V_{GS}$; $T_j = 175 \text{ °C}$; see <u>Figure 10</u> | 1 | - | - | V |
| | | $I_D = 1 \text{ mA}$; $V_{DS} = V_{GS}$; $T_j = -55 \text{ °C}$; see Figure 10 | - | - | 4.4 | V |
| | | $I_D = 1$ mA; $V_{DS} = V_{GS}$; $T_j = 25$ °C; see Figure 10 | 2 | 3 | 4 | V |
| I _{DSS} | drain leakage current | $V_{DS} = 55 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$ | - | 0.05 | 10 | μΑ |
| | | $V_{DS} = 55 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 175 ^{\circ}\text{C}$ | - | - | 500 | μΑ |
| I _{GSS} | gate leakage current | $V_{GS} = 20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$ | - | 2 | 100 | nA |
| | | $V_{GS} = -20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$ | - | 2 | 100 | nA |
| R _{DSon} | drain-source on-state resistance | $V_{GS} = 10 \text{ V}; I_D = 10 \text{ A}; T_j = 175 ^{\circ}\text{C};$ see Figure 11 and 12 | - | - | 150 | mΩ |
| | | $V_{GS} = 10 \text{ V}; I_D = 10 \text{ A}; T_j = 25 ^{\circ}\text{C};$ see Figure 11 and 12 | - | 64 | 75 | mΩ |
| Dynamic | characteristics | | | | | |
| Q _{G(tot)} | total gate charge | $I_D = 25 \text{ A}$; $V_{DS} = 44 \text{ V}$; $V_{GS} = 10 \text{ V}$; | - | 11 | - | nC |
| Q _{GS} | gate-source charge | T _j = 25 °C;see <u>Figure 13</u> | - | 3 | - | nC |
| Q_{GD} | gate-drain charge | | - | 6 | - | nC |
| C _{iss} | input capacitance | $V_{DS} = 25 \text{ V}; V_{GS} = 0 \text{ V}; f = 1 \text{ MHz};$ | - | 320 | 483 | pF |
| C _{oss} | output capacitance | T _j = 25 °C;see <u>Figure 14</u> | - | 92 | 113 | pF |
| C _{rss} | reverse transfer capacitance | | - | 64 | 90 | pF |
| t _{d(on)} | turn-on delay time | $V_{DS} = 30 \text{ V}; R_L = 1.2 \Omega; V_{GS} = 10 \text{ V};$ | - | 10 | - | ns |
| t _r | rise time | $R_{G(ext)} = 10 \Omega$; $T_j = 25 °C$ | - | 50 | - | ns |
| t _{d(off)} | turn-off delay time | | - | 70 | - | ns |
| t _f | fall time | | - | 40 | - | ns |
| L _D | internal drain inductance | from drain lead 6 mm from package to centre of die; T _i = 25 °C | - | 4.5 | - | nΗ |
| | | from contact screw on mounting base to centre of die; T _j = 25 °C | - | 3.5 | - | nΗ |
| L _S | internal source inductance | from source lead to source bond pad; $T_j = 25 ^{\circ}\text{C}$ | - | 7.5 | - | nΗ |
| Source-di | rain diode | | | | | |
| V_{SD} | source-drain voltage | $I_S = 25 \text{ A}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C};$ see <u>Figure 15</u> | - | 0.85 | 1.2 | V |
| t _{rr} | reverse recovery time | $I_S = 20 \text{ A}; dI_S/dt = -100 \text{ A/}\mu\text{s}; V_{GS} = -10 \text{ V};$ | - | 32 | - | ns |
| Q _r | recovered charge | $V_{DS} = 30 \text{ V}; T_j = 25 \text{ °C}$ | - | 120 | - | nC |

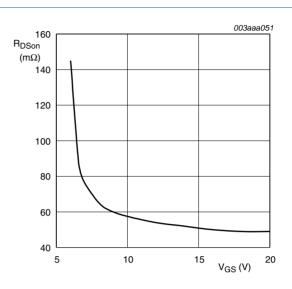
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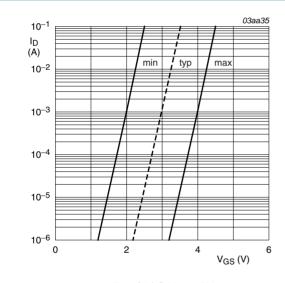
 $T_j = 25$ °C; $t_p = 300 \mu s$

Fig 5. Output characteristics: drain current as a function of drain-source voltage; typical values



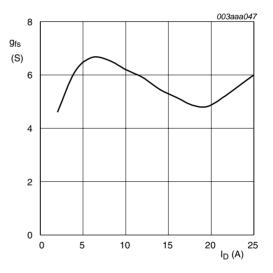
$$T_j = 25^{\circ}C; I_D = 25A$$

Fig 6. Drain-source on-state resistance as a function of gate-source voltage; typical values



 $T_j = 25 \,^{\circ}C; V_{DS} = 5V$

Fig 7. Sub-threshold drain current as a function of gate-source voltage



 $T_j=25^{\circ}C; V_{DS}=25V$

Fig 8. Forward transconductance as a function of drain current; typical values

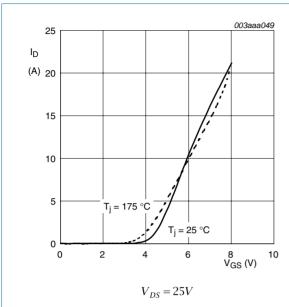
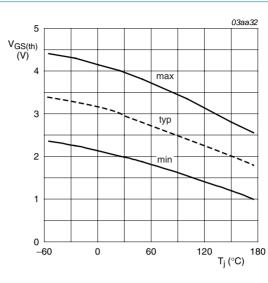


Fig 9. Transfer characteristics: drain current as a function of gate-source voltage; typical values



$$I_D = 1 \, mA; V_{DS} = V_{GS}$$

Fig 10. Gate-source threshold voltage as a function of junction temperature

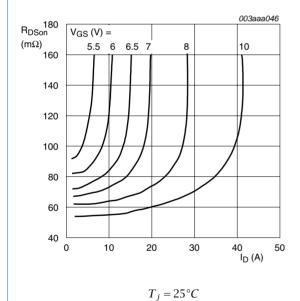
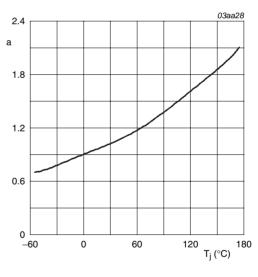


Fig 11. Drain-source on-state resistance as a function of drain current; typical values

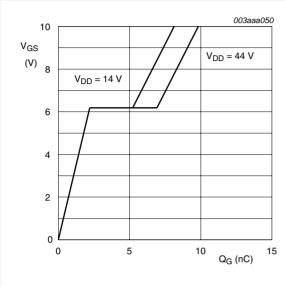


 $a = \frac{R_{DSon}}{R_{DSon(25^{\circ}C)}}$

Fig 12. Normalized drain-source on-state resistance factor as a function of junction temperature

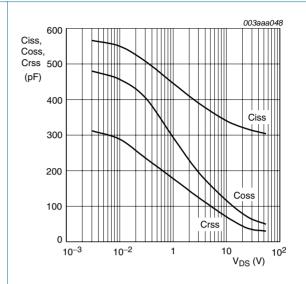
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 $T_j = 25^{\circ}C; I_D = 25A$

Fig 13. Gate-source voltage as a function of gate charge; typical values



$$V_{GS} = 0V; f = 1MHz$$

Fig 14. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

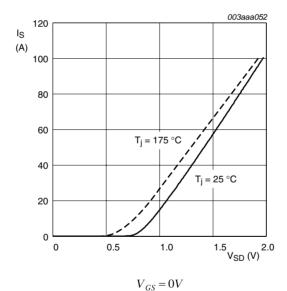
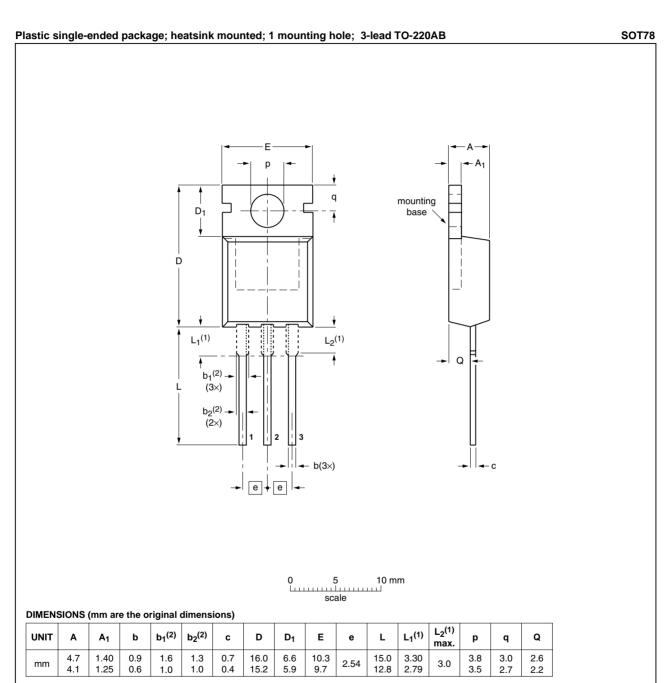


Fig 15. Source current as a function of source-drain voltage; typical values

Package outline



- Lead shoulder designs may vary.
 Dimension includes excess dambar.

| OUTLINE | | REFERENCES | | | | EUROPEAN | ISSUE DATE | |
|---------|---------|------------|-----------------|-------|--|------------|---------------------------------|--|
| | VERSION | IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE | |
| | SOT78 | | 3-lead TO-220AB | SC-46 | | | 08-04-23 08-06-13 | |

Fig 16. Package outline SOT78 (TO-220AB)

8. Revision history

Table 7. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|------------------------|---------------------------------|--|--------------------|------------------------------|
| PHP20N06T_2 | 20091127 | Product data sheet | - | PHP20N06T_PHB20N06T-01 |
| Modifications: | | t of this data sheet has b of NXP Semiconductors | • | comply with the new identity |
| | Legal texts | s have been adapted to the | ne new company n | ame where appropriate. |
| | Type num | ber PHP20N06T separat | ed from data sheet | PHP20N06T_PHB20N06T-01. |
| PHP20N06T_PHB20N06T-01 | 20010222 | Product specification | - | - |

9. Legal information

9.1 Data sheet status

| Document status[1][2] | Product status[3] | Definition |
|--------------------------------|-------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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STF5N65M6 IRF40H233XTMA1 STU5N65M6 DMN6022SSD-13 DMN13M9UCA6-7 DMTH10H4M6SPS-13 DMN2990UFB-7B
IPB80P04P405ATMA2 2N7002W-G MCAC30N06Y-TP MCQ7328-TP BXP7N65D BXP4N65F AOL1454G WMJ80N60C4 BXP2N20L
BXP2N65D BXT1150N10J BXT1700P06M TSM60NB380CP ROG RQ7L055BGTCR DMNH15H110SK3-13 SLF10N65ABV2
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